



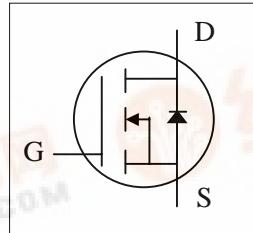
**Advanced Power
Electronics Corp.**

AP2761P-A

Pb Free Plating Product

**N-CHANNEL ENHANCEMENT MODE
POWER MOSFET**

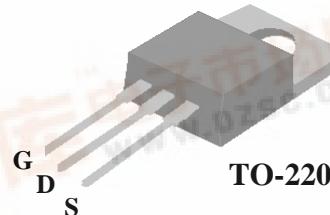
- ▼ Lower On-resistance
- ▼ Fast Switching Characteristic
- ▼ Simple Drive Requirement
- ▼ RoHS Compliant



BV_{DSS}	650V
$R_{DS(ON)}$	1Ω
I_D	10A

Description

The TO-220 package is universally preferred for all commercial-industrial applications. The device is suited for DC-DC ,AC-DC converters for power applications.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	650	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	10	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	4.4	A
I_{DM}	Pulsed Drain Current ¹	18	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	104	W
	Linear Derating Factor	0.8	W/ $^\circ C$
I_{AR}	Avalanche Current	10	A
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Units
R_{thj-c}	Thermal Resistance Junction-case	Max.	$^\circ C/W$
R_{thj-a}	Thermal Resistance Junction-ambient	Max.	$^\circ C/W$



AP2761P-A

Electrical Characteristics @ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=1\text{mA}$	650	-	-	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_D=1\text{mA}$	-	0.6	-	$\text{V}/^\circ\text{C}$
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=3.5\text{A}$	-	-	1	Ω
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D=250\mu\text{A}$	2	-	4	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_D=3.5\text{A}$	-	4.5	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{\text{DS}}=600\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	10	μA
	Drain-Source Leakage Current ($T_j=150^\circ\text{C}$)	$V_{\text{DS}}=480\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	100	μA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}=\pm 30\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge ³	$I_D=10\text{A}$	-	53	85	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=520\text{V}$	-	10	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{\text{GS}}=10\text{V}$	-	15	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time ³	$V_{\text{DD}}=320\text{V}$	-	16	-	ns
t_r	Rise Time	$I_D=10\text{A}$	-	20	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time	$R_G=10\Omega$, $V_{\text{GS}}=10\text{V}$	-	82	-	ns
t_f	Fall Time	$R_D=32\Omega$	-	36	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	2770	4430	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=15\text{V}$	-	320	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	8	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ³	$I_S=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	-	1.5	V
t_{rr}	Reverse Recovery Time ³	$I_S=10\text{A}$, $V_{\text{GS}}=0\text{V}$,	-	610	-	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100\text{A}/\mu\text{s}$	-	8.64	-	μC

Notes:

1. Pulse width limited by safe operating area.
2. Starting $T_j=25^\circ\text{C}$, $V_{\text{DD}}=50\text{V}$, $L=1.2\text{mH}$, $R_G=25\Omega$, $I_{\text{AS}}=10\text{A}$.
3. Pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.

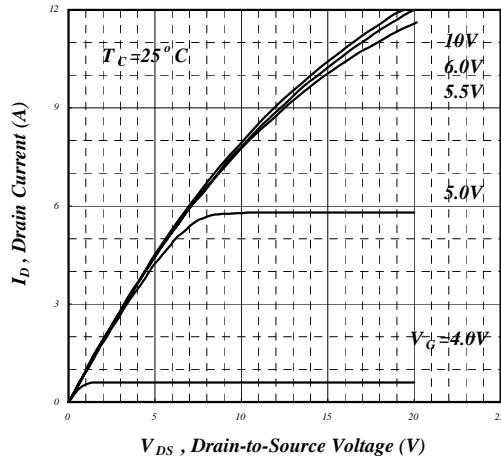


Fig 1. Typical Output Characteristics

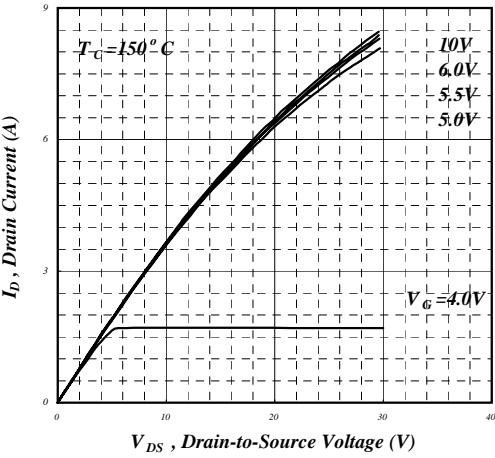


Fig 2. Typical Output Characteristics

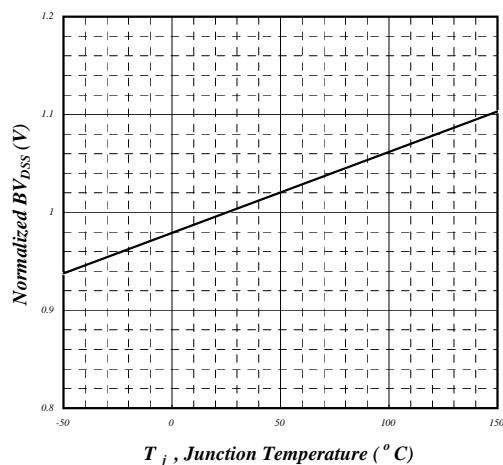


Fig 3. On-Resistance v.s. Gate Voltage

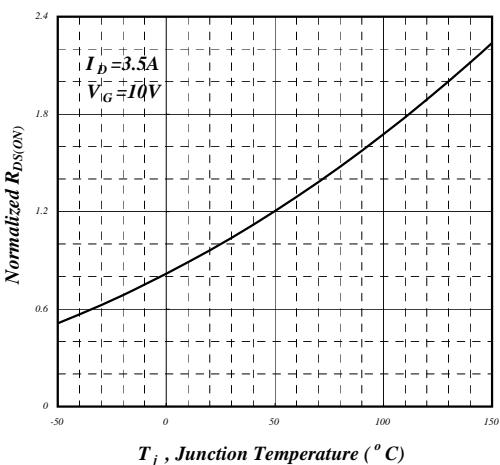


Fig 4. Normalized On-Resistance v.s. Junction Temperature

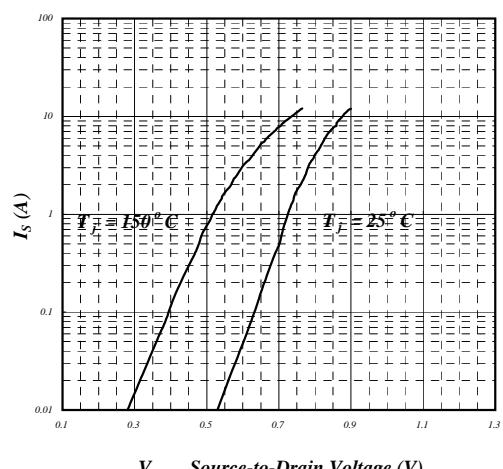


Fig 5. Forward Characteristic of Reverse Diode

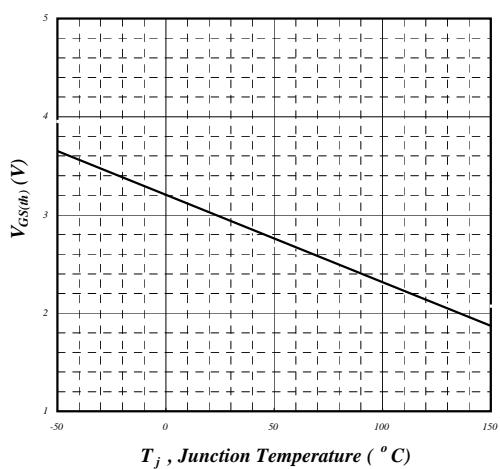


Fig 6. Gate Threshold Voltage v.s. Junction Temperature



AP2761P-A

